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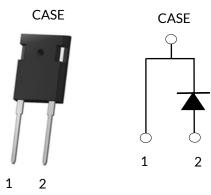








## UJ3D1220K2



## Silicon Carbide (SiC) Diode - EliteSiC, TO-247-2L, 20 A, 1200 V SiC Merged PiN-Schottky (MPS) Diode

Rev. C, Jan 2025

#### Description

UnitedSiC offers the  $3^{rd}$  generation of high performance SiC Merged-PiN-Schottky (MPS) diodes. With zero reverse recovery charge and  $175^{\circ}$ C maximum junction temperature, these diodes are ideally suited for high frequency and high efficiency power systems with minimum cooling requirements.

#### **Features**

- Maximum operating temperature of 175°C
- Easy paralleling
- Extremely fast switching not dependent on temperature
- No reverse or forward recovery
- Enhanced surge current capability, MPS structure
- 100% UIS tested

| Part Number | Package   | Marking    |
|-------------|-----------|------------|
| UJ3D1220K2  | TO-247-2L | UJ3D1220K2 |







#### **Typical applications**

- Power converters
- Industrial motor drives
- Switch mode power supplies
- Power factor correction modules













#### **Maximum Ratings**

| Parameter   | Symbol                            | <b>Test Conditions</b>                   | Value      | Units  |  |
|---|-----------------------------------|--|------------|--------|--|
| DC blocking voltage   | V <sub>R</sub>                    |  | 1200       | V      |  |
| Repetitive peak reverse voltage, T <sub>J</sub> =25°C       | $V_{RRM}$                         |  | 1200       | V      |  |
| Surge peak reverse voltage                                  | $V_{RSM}$                         |  | 1200       | V      |  |
| Maximum DC forward current                                  | I <sub>F</sub>                    | T <sub>C</sub> = 135°C                   | 20         | Α      |  |
| Non-repetitive forward surge current                        | 1                                 | $T_C = 25$ °C, $t_p = 10$ ms             | 190        | А      |  |
| sine halfwave   | I <sub>FSM</sub>                  | $T_C = 110^{\circ}C, t_p = 10 \text{ms}$ | 180        |        |  |
| Repetitive forward surge current                            | 1                                 | $T_C = 25$ °C, $t_p = 10$ ms             | 71.9       | А      |  |
| sine halfwave, D=0.1  | I <sub>FRM</sub>                  | $T_C = 110^{\circ}C, t_p = 10 \text{ms}$ | 40.9       |        |  |
| Non-repetitive peak forward current                         | I <sub>F,max</sub>                | $T_C = 25^{\circ}C, t_p = 10 \mu s$      | 1300       |        |  |
|   |                                   | $T_C = 110^{\circ}C, t_p = 10\mu s$      | 1300       | Α      |  |
| •2.   | ∫i²dt                             | $T_C = 25$ °C, $t_p = 10$ ms             | 181        | $A^2s$ |  |
| i <sup>2</sup> t value                                      |                                   | $T_C = 110^{\circ}C, t_p = 10 \text{ms}$ | 162        |        |  |
| Power dissipation   | P <sub>tot</sub>                  | T <sub>C</sub> = 25°C                    | 205        | W      |  |
|   |                                   | T <sub>C</sub> = 135°C                   | 55         |        |  |
| Maximum junction temperature                                | $T_{J,max}$                       |  | 175        | °C     |  |
| Operating and storage temperature                           | T <sub>J</sub> , T <sub>STG</sub> |  | -55 to 175 | °C     |  |
| Soldering temperatures, wavesoldering only allowed at leads | $T_{sold}$                        | 1.6mm from case for 10s                  | 260        | °C     |  |

#### **Thermal Characteristics**

| Parameter                            | Symbol          | Test Conditions | Value |      |      | Units |
|--------------------------------------|-----------------|-----------------|-------|------|------|-------|
|                                      |                 |                 | Min   | Тур  | Max  | Units |
| Thermal resistance, junction-to-case | $R_{\theta IC}$ |                 |       | 0.56 | 0.73 | °C/W  |

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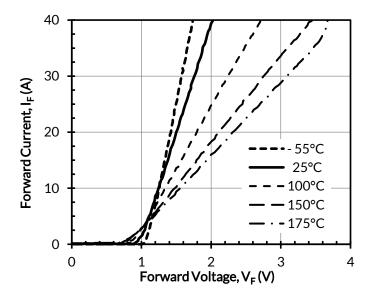


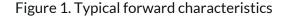
## Electrical Characteristics (T<sub>J</sub> = +25°C unless otherwise specified)

| Parameter                              | Symbol         | Test Conditions                              | Value |      |     | Units  |
|--|----------------|--|-------|------|-----|--------|
|  |                |  | Min   | Тур  | Max | UIIILS |
| Forward voltage                        | V <sub>F</sub> | I <sub>F</sub> = 20A, T <sub>J</sub> =25°C   | -     | 1.52 | 1.7 | V      |
|  |                | I <sub>F</sub> = 20A, T <sub>J</sub> =150°C  | -     | 2.15 |     |        |
|  |                | I <sub>F</sub> = 20A, T <sub>J</sub> =175°C  | -     | 2.25 |     |        |
| Reverse current                        | I <sub>R</sub> | V <sub>R</sub> =1200V, T <sub>J</sub> =25°C  | -     | 18   | 190 | μΑ     |
|  |                | V <sub>R</sub> =1200V, T <sub>J</sub> =175°C | -     | 500  |     |        |
| Total capacitive charge <sup>(1)</sup> | $Q_{C}$        | V <sub>R</sub> =800V                         |       | 83   |     | nC     |
| Total capacitance                      | С              | $V_R=1V, f=1MHz$                             |       | 810  |     | pF     |
|  |                | V <sub>R</sub> =400V, f = 1MHz               |       | 75   |     |        |
|  |                | V <sub>R</sub> =800V, f = 1MHz               |       | 69   |     |        |
| Capacitance stored energy              | E <sub>C</sub> | V <sub>R</sub> =800V                         |       | 24.5 |     | μЈ     |

(1)  $Q_c$  is independent on  $T_J$ ,  $di_F/dt$ , and  $I_F$  as shown in the application note USCi\_AN0011.

#### **Typical Performance Diagrams**





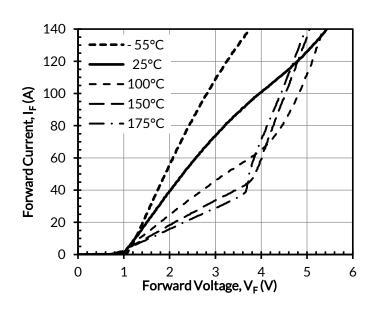


Figure 2. Typical forward characteristics in surge current



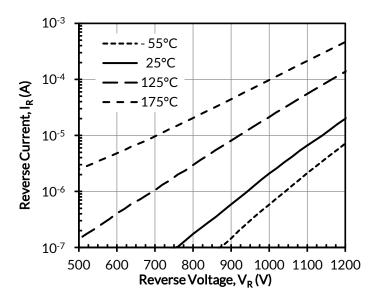








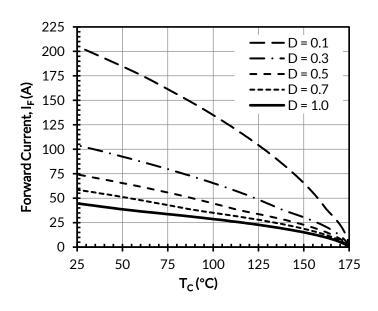




Power Disspiation, P<sub>Tot</sub> (W) T<sub>C</sub> (°C)

Figure 3. Typical reverse characteristics

Figure 4. Power dissipation



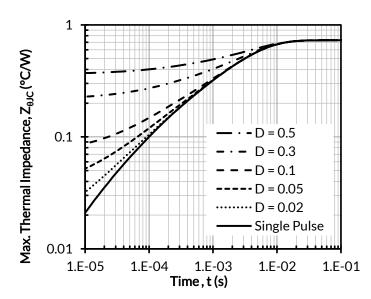


Figure 5. Diode forward current

Figure 6. Maximum transient thermal impedance

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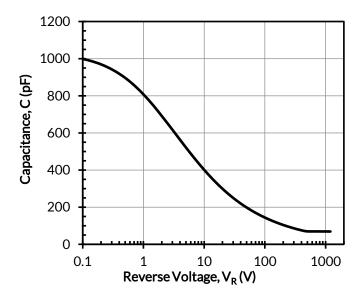












120
100
80
40  $Q_{c} = \int_{0}^{V_{R}} C(V) dV$ 0
20  $Q_{c} = \int_{0}^{V_{R}} C(V) dV$ Reverse Voltage,  $V_{R}$  (V)

Figure 7. Capacitance vs. reverse voltage at 1MHz

Figure 8. Typical capacitive charge vs. reverse voltage

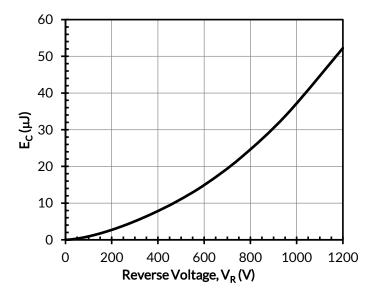


Figure 9. Typical capacitance stored energy vs. reverse voltage













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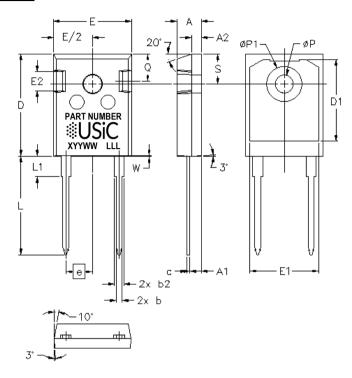
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# TO-247-2L PACKAGE OUTLINE, PART MARKING AND TUBE SPECIFICATIONS

### **PACKAGE OUTLINE**

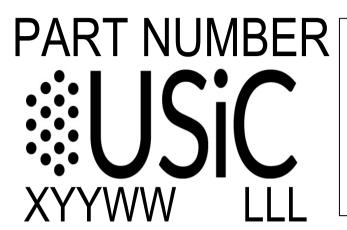


| SYM | INCHES |       | MILLIMETERS |          |  |
|-----|--------|-------|-------------|----------|--|
|     | MIN    | MAX   | MIN         | MAX      |  |
| Α   | 0.185  | 0.209 | 4.70        | 5.31     |  |
| A1  | 0.087  | 0.102 | 2.21        | 2.61     |  |
| A2  | 0.059  | 0.098 | 1.50        | 2.49     |  |
| b   | 0.039  | 0.055 | 0.99        | 1.40     |  |
| b2  | 0.065  | 0.094 | 1.65        | 2.39     |  |
| b4  | 0.102  | 0.135 | 2.59        | 3.43     |  |
| С   | 0.015  | 0.035 | 0.38        | 0.89     |  |
| D   | 0.819  | 0.845 | 20.80       | 21.46    |  |
| D1  | 0.515  | -     | 13.08       | -        |  |
| D2  | 0.02   | 0.053 | 0.51        | 1.35     |  |
| E   | 0.610  | 0.640 | 15.49       | 16.26    |  |
| е   | 0.214  | 4 BSC | 5.44        | 5.44 BSC |  |
| E1  | 0.530  | -     | 13.46       | -        |  |
| E2  | 0.135  | 0.157 | 3.43        | 3.99     |  |
| L   | 0.780  | 0.800 | 19.81       | 20.32    |  |
| L1  | -      | 0.177 | -           | 4.50     |  |
| ØΡ  | 0.140  | 0.144 | 3.56        | 3.66     |  |
| ØP1 | 0.278  | 0.291 | 7.06        | 7.39     |  |
| Q   | 0.212  | 0.244 | 5.39        | 6.20     |  |
| S   | 0.243  | 3 BSC | 6.17 BSC    |          |  |
| W   | -      | 0.006 | -           | 0.15     |  |



# TO-247-2L PACKAGE OUTLINE, PART MARKING AND TUBE SPECIFICATIONS

#### **PART MARKING**



PART NUMBER = REFER TO
DS PN DECODER FOR DETAILS

X = ASSEMBLY SITE

YY = YEAR

WW = WORK WEEK

LLL = LOT ID

#### **PACKING TYPE**

**ANTI-STATIC TUBE** 

**QUANTITY /TUBE: 30 UNITS** 

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